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Committee on WIPO Standards (CWS)

Eleventh Session Geneva, December 4 to 8, 2023

PROPOSAL FOR A DRAFT SURVEY QUESTIONNAIRE ON THE IMPLEMENTATION OF WIPO STANDARD ST.91

Document prepared by the 3D Task Force Leader

SUMMARY

1. WIPO Standard ST.91 was adopted by the Committee on WIPO Standards (CWS) at its ninth session. The 3D Task Force Leader is proposing a draft questionnaire for approval by the CWS to better understand the scale of implementation of this Standard and any future revisions that may be required.

BACKGROUND

2. At its sixth session, the CWS noted a proposal from the Russian Federation that broader acceptance of 3D formats by Intellectual Property Offices (IPOs) could better serve user needs, and the use of 3D formats could allow more efficient methods of search and comparative analysis. As a result, Task No.61 was established with the following description:

"Prepare a proposal for recommendations on three-dimensional (3D) models and images"

At the same session, the CWS approved the creation of the 3D Task Force to perform this Task, with the Russian Federation designated as the Task Force leader. (See paragraphs 141 to 142 of document CWS/6/34.)

- 3. At its ninth session, the CWS adopted WIPO Standard ST.91, with the name "Recommendations on digital three-dimensional (3D) models and 3D images", with the objective to cope with new demands from IPOs, IP users, and other stakeholders (see paragraph 31 of CWS/9/25). The Standard recommends file formats and treatment of 3D objects for receiving, processing, and publishing IP applications which contain 3D models or 3D images in patent, trademark and industrial designs documentation. It aims to help establish common 3D formats to facilitate filings at multiple IPOs, reduce processing time, facilitate data exchange between IPOs, harmonize filing requirements, and create guidelines for publishing IP data with digital 3D objects.
- 4. Following the adoption of the WIPO Standard ST.91 at the ninth session of the CWS, the modified description of Task No.61 was approved by the CWS, which reads:
 - "Ensure the necessary revisions and updates of WIPO Standard ST.91, including methods of search for 3D models and 3D images".
- 5. At its tenth session, the CWS noted that the Task Force plans to develop and discuss search and comparison methods for 3D visual representations in line with the updated Task description. The Task Force Leader noted that Task Force Members need more time to work on 3D search methods, given the ongoing investigations and studies, as well as limited experience that many Task Force Members currently have with the subject matter (see paragraph 122 of document CWS/10/22). Following the discussion within the Task Force it is planned to present an agreed proposal for a respective update at future sessions of the CWS.

PROPOSED QUESTIONNAIRE

- 6. The Task Force believes that the adopted WIPO ST.91 is relatively new, therefore there is no need for its urgent update and revision, except the agreed editorial remarks from the Task Force Members.
- 7. At the same time, it is an appropriate time to collect information on how widely WIPO Standard ST.91 is used and implemented by IPOs, as well as industry and users, and to which extent and for what IP rights. Therefore, the Task Force presents a draft questionnaire as reproduced in the Annex to the present document for consideration and approval by the CWS at this session. This draft questionnaire is intended to collect information that could be then used as a guideline for further update and revisions of WIPO Standard ST.91. This will also raise the visibility of this Standard with Member States who may wish to participate in the Task Force.
- 8. The Task Force Leader also suggests that the CWS request the Secretariat to issue a Circular inviting its Members and Observers to respond to the questionnaire once it is approved at this session. The Task Force will analyze responses to the survey and report the results to the next session of the Committee.

9. The CWS is invited to:

- (a) note the contents of the present documents;
- (b) review and approve the contents of the draft questionnaire indicated above in paragraphs 6 and 7 above and reproduced as the Annex to the present document; and
- (c) request the Secretariat to issue a Circular inviting its Members and Observers to participate in the survey and the 3D Task Force to report the results of the survey as indicated in paragraph 8 above.

[Annex follows]

Draft survey questionnaire on the implementation of WIPO Standard ST.91

Q 1. Does your Office currently use 3D models, 3D images or 3D chemical structures?

□ Yes □ No						
☐ Other (please speci	fy)					
Q1.1. If yes, for what IP r	ights:					
☐ Designs						
☐ Inventions						
☐ Utility models						
☐ Integrated circuit to	pology					
\square Other (please speci	fy)					
Q 1.2. Does your Office in ☐ Yes, fully ☐ Partially ☐ No	mplement WI					
Q 2. Using 3D models, 3 Q 2.1. What formats of 3I accept for each IP right?	_					ice currently Inventions
Q 2. Using 3D models, 3 Q 2.1. What formats of 3I	D models, 3D	images or 3	Inventions (except 3D chemical	structures (does your Off	_
Q 2. Using 3D models, 3 Q 2.1. What formats of 3I	D models, 3D	images or 3	Inventions (except 3D	structures o	lntegrated circuit	Inventions (3D chemical
Q 2. Using 3D models, 3 Q 2.1. What formats of 3I accept for each IP right?	D models, 3D Trademarks	Designs	Inventions (except 3D chemical	Utility models	Integrated circuit topology	Inventions (3D chemical
Q 2. Using 3D models, 3 Q 2.1. What formats of 3I accept for each IP right? none, IPO doesn't operate this type of IP right none, IPO doesn't accept 3D models, 3D images or 3D chemical structures for	D models, 3D Trademarks	Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology	Inventions (3D chemical structures)
Q 2.1. What formats of 3I accept for each IP right? none, IPO doesn't operate this type of IP right none, IPO doesn't accept 3D models, 3D images or 3D chemical structures for this type of IP right	D models, 3D Trademarks	Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology	Inventions (3D chemical structures)
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Q 2. Using 3D models, 3 Q 2.1. What formats of 3I accept for each IP right? none, IPO doesn't operate this type of IP right none, IPO doesn't accept 3D models, 3D images or 3D chemical structures for this type of IP right 3D pdf ges obj stl step/stp	D models, 3D	Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology	Inventions (3D chemical structures)

Q 2.2. What software does 3D chemical structures dependent of the Please specify:			ualization c	f 3D models,	3D images o
Q 2.3. What formats of 3 use for the electronic pub		Inventions (except 3D chemical		Integrated circuit topology	Inventions (3D chemical structures)
none, IPO doesn't operate		structures)			
his type of IP right none, IPO doesn't publish nformation of this type of P right electronically					
none, IPO doesn't publish aformation of 3D models, and images or 3D chemical attructures electronically even if they were accepted					
PD images received by PO from the source 3D nodels or 3D images					
SD pdf					
ges					
bj					
tl					
tep/stp					
3d					
nol					
dx					
☐ Other (please specify)				lication of 3D	madala 2D

Q 2.5. What formats of 3 use for the paper publica				3D chem	nical	structures	s does y	our Of	fice currently
	Trademarks	Desi	gns	Inventice (except 3D chemical structur	al	Utility models	Integr circuit topolo	t	Inventions (3D chemical structures)
none, IPO doesn't operate this type of IP right									
none, IPO doesn't publish information of this type of IP right on paper									
none, IPO doesn't publish information of 3D models, 3D images or 3D chemical structures on paper even if they were accepted									
2D images received by Office from the source 3D models or 3D images									
link to the 3D object online									
☐ Other (please specify))								
Q 2.6. Does your Office with 3D models and 3D each IP right?	images durin	g the			oces	ss and if s			
	Tradema	arks	Desig	ns	(exc	entions cept 3D emical actures)	Utility models		Integrated circuit topology
no									
yes, IPO use 2D representations of 3D mode for the comparison	ls								
yes, IPO use 3D models themselves for the comparis	on]					
☐ Other (please specify))		•					4	

Trademarks	Designs			
	Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology
		e comparison	of the 3D m	odels and 3D
ure plans				
ng practices/fu ur Office	ture plans for u	using 3D mode	els, 3D imag	es or 3D
	ure plans	ure plans	our Office currently use for the comparison g the examination process? ure plans ag practices/future plans for using 3D mode	our Office currently use for the comparison of the 3D mg the examination process? ure plans ug practices/future plans for using 3D models, 3D image

Q 4. Any other comments		
Please specify:		